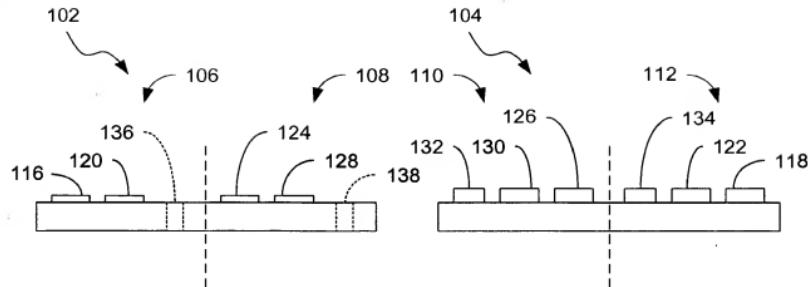
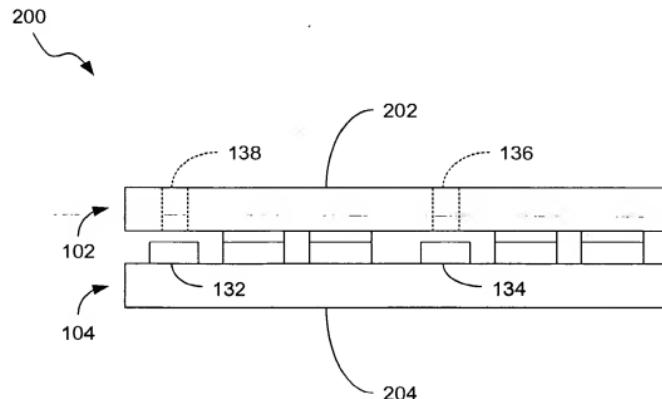


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Title: Methods for Dicing Wafer Stacks to Provide . . .
Inventors: Hartwell, et al. Docket No. 10006165-1
Page 1 of 8
Replacement Sheet



**FIG. 1
(PRIOR ART)**



**FIG. 2
(PRIOR ART)**

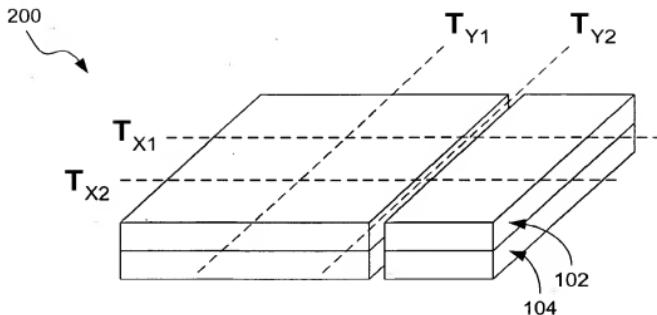


FIG. 3
(PRIOR ART)

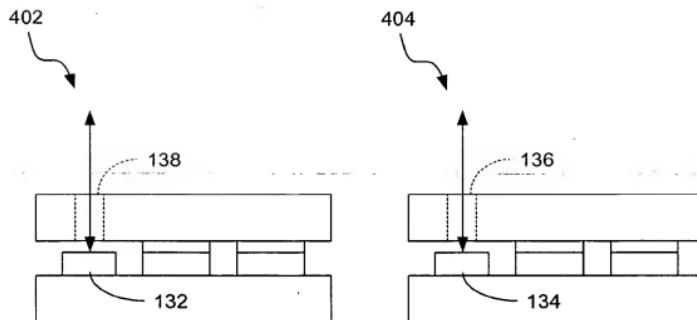


FIG. 4
(PRIOR ART)

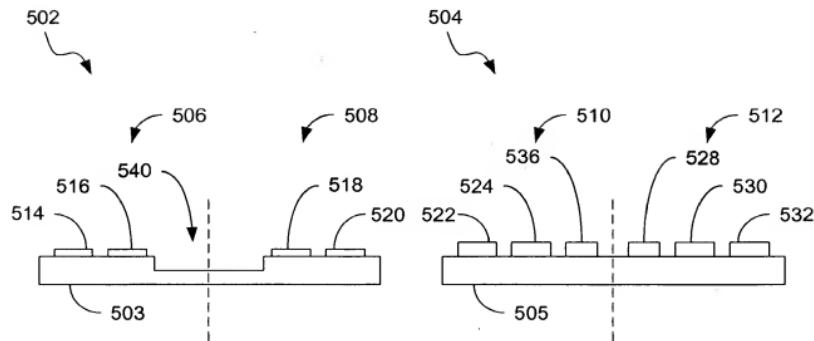


FIG. 5

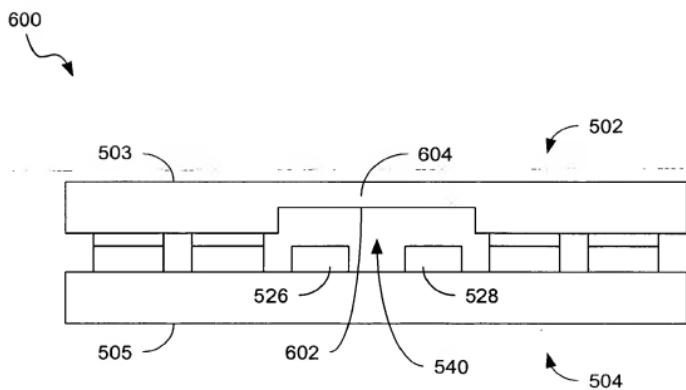


FIG. 6

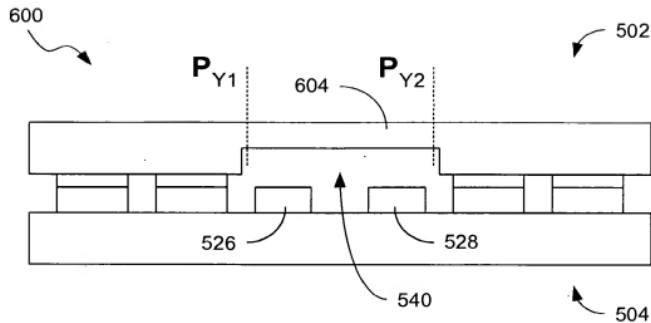


FIG. 7

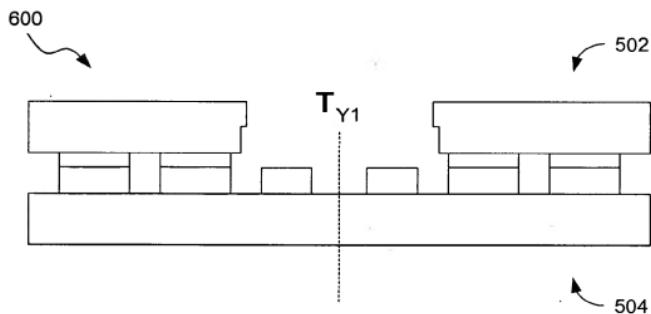


FIG. 8

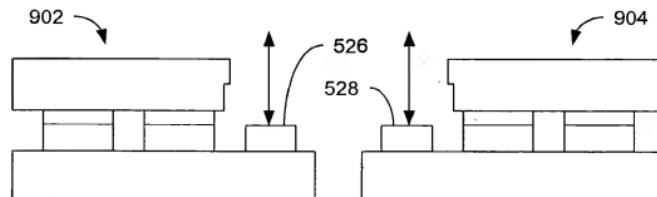


FIG. 9

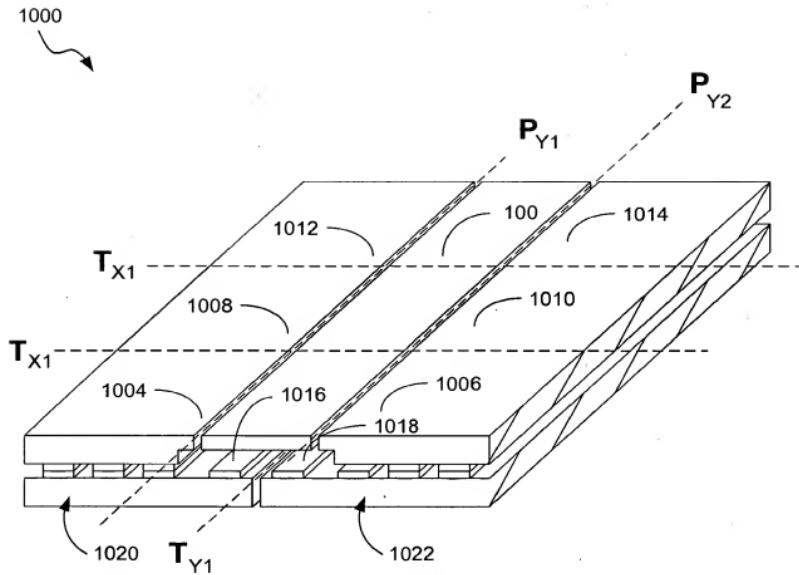


FIG. 10

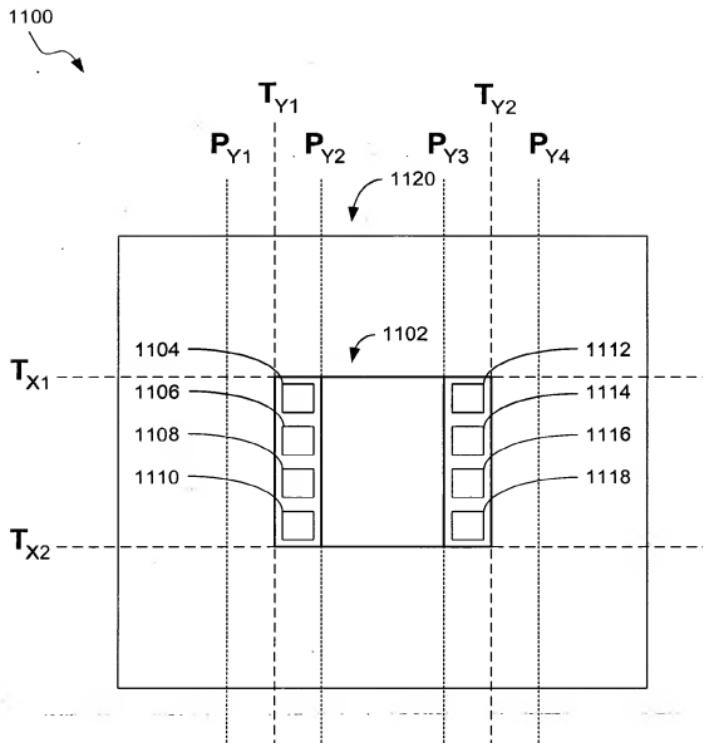


FIG. 11

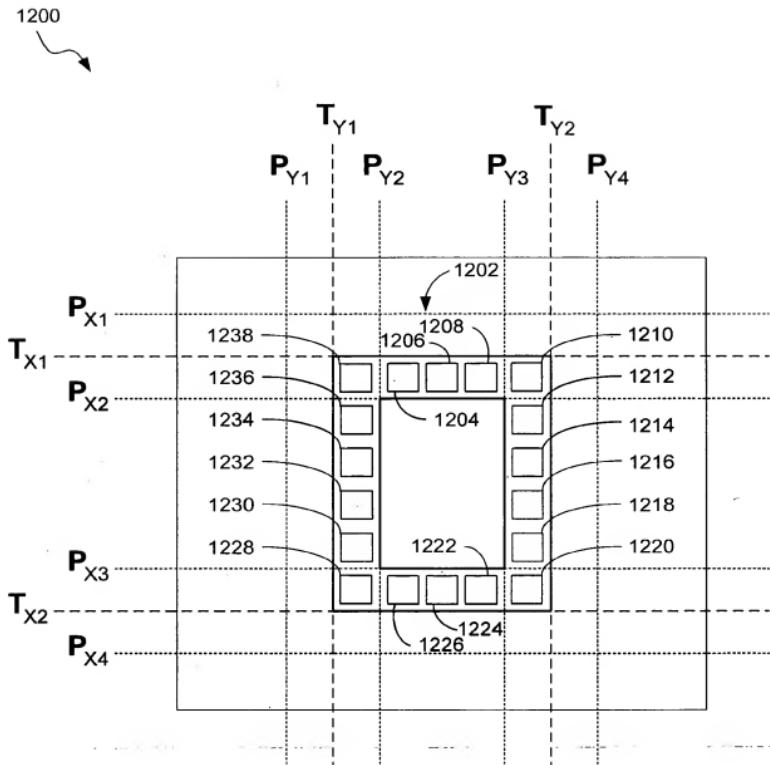


FIG. 12

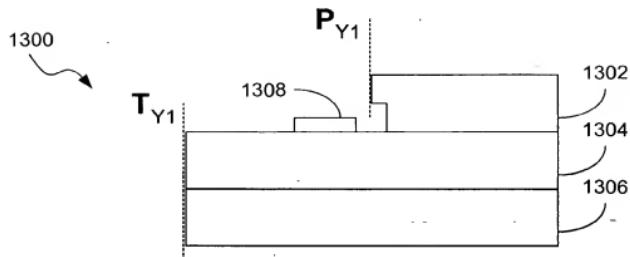


FIG. 13

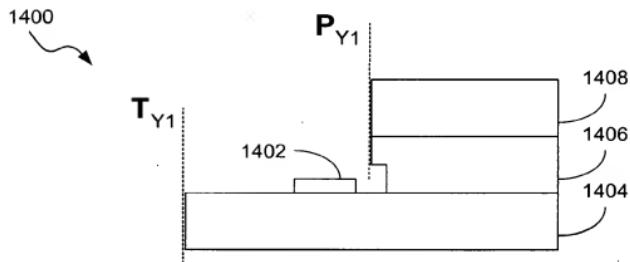


FIG. 14

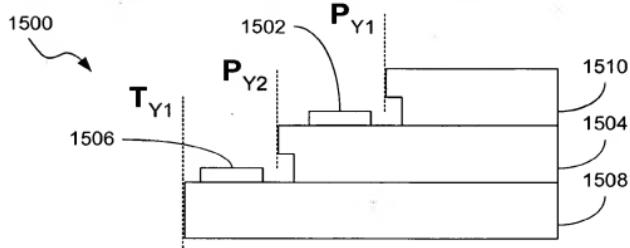


FIG. 15